

## Normally – OFF Silicon Carbide Junction Transistor

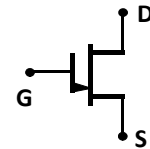
|              |   |               |
|--------------|---|---------------|
| $V_{DS}$     | = | <b>650 V</b>  |
| $V_{DS(ON)}$ | = | <b>1.5 V</b>  |
| $I_D$        | = | <b>15 A</b>   |
| $R_{DS(ON)}$ | = | <b>105 mΩ</b> |

### Features

- 250 °C maximum operating temperature
- Temperature independent switching performance
- Electrically isolated base-plate
- Gate oxide free SiC switch
- Suitable for connecting an anti-parallel diode
- Positive temperature coefficient for easy paralleling
- Low gate charge
- Low intrinsic capacitance

### Package

- RoHS Compliant



**TO – 257 (Isolated Base-plate Hermetic Package)**

### Advantages

- Low switching losses
- Higher efficiency
- High temperature operation
- High short circuit withstand capability

### Applications

- Down Hole Oil Drilling, Geothermal Instrumentation
- Hybrid Electric Vehicles (HEV)
- Solar Inverters
- Switched-Mode Power Supply (SMPS)
- Power Factor Correction (PFC)
- Induction Heating
- Uninterruptible Power Supply (UPS)
- Motor Drives

### Maximum Ratings at $T_j = 250\text{ °C}$ , unless otherwise specified

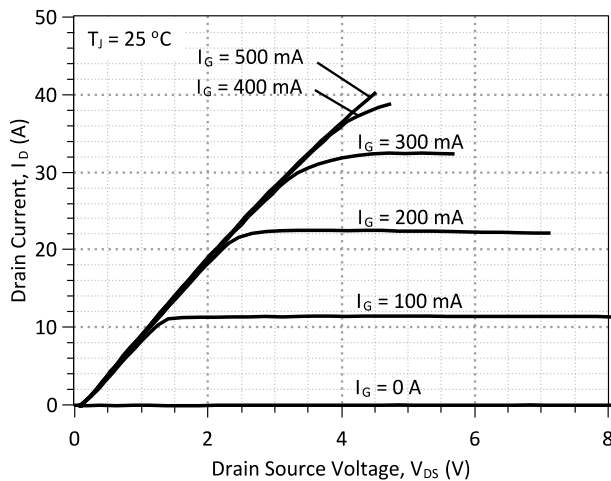
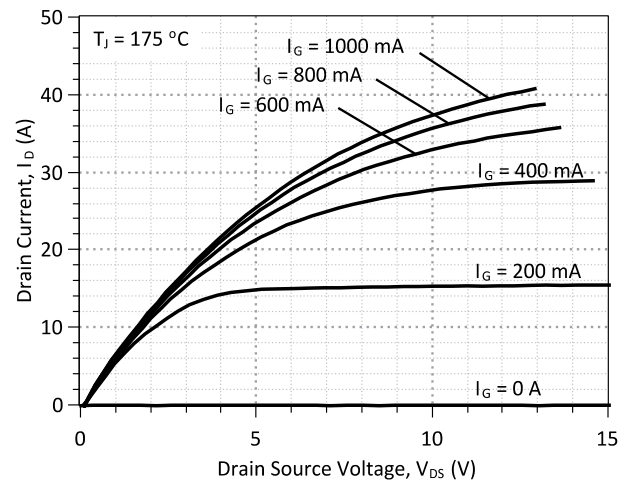
| Parameter                         | Symbol         | Conditions            | Values     | Unit |
|-----------------------------------|----------------|-----------------------|------------|------|
| Drain – Source Voltage            | $V_{DS}$       | $V_{GS} = 0\text{ V}$ | 650        | V    |
| Continuous Drain Current          | $I_D$          | $T_C = 155\text{ °C}$ | 15         | A    |
| Gate Peak Current                 | $I_{GM}$       |                       | 5          | A    |
| Reverse Gate – Source Voltage     | $V_{GS}$       |                       | 30         | V    |
| Reverse Drain – Source Voltage    | $V_{DS}$       |                       | 40         | V    |
| Power Dissipation                 | $P_{tot}$      | $T_C = 25\text{ °C}$  | 22         | W    |
| Operating and Storage Temperature | $T_j, T_{stg}$ |                       | -55 to 250 | °C   |

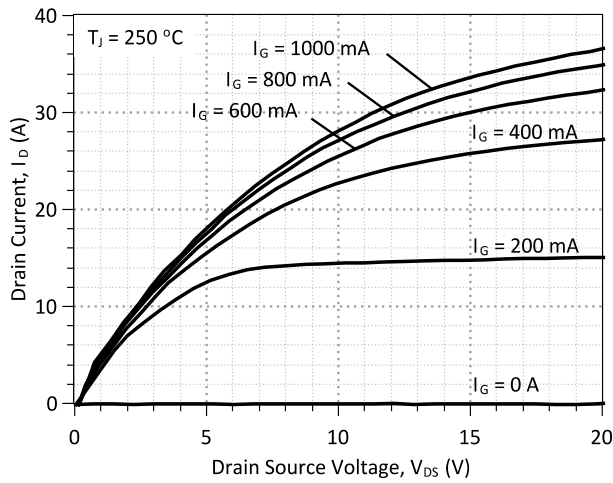
### Electrical Characteristics at $T_j = 250\text{ °C}$ , unless otherwise specified

| Parameter                    | Symbol        | Conditions   | Values |      |      | Unit |
|------------------------------|---------------|--|--------|------|------|------|
|                              |               |  | min.   | typ. | max. |      |
| <b>On Characteristics</b>    |               |  |        |      |      |      |
| Drain – Source On Voltage    | $V_{DS(ON)}$  | $I_D = 15\text{ A}, I_G = 500\text{ mA}, T_j = 25\text{ °C}$   |        | 1.5  |      | V    |
|                              |               | $I_D = 15\text{ A}, I_G = 1000\text{ mA}, T_j = 175\text{ °C}$ |        | 2.4  |      |      |
|                              |               | $I_D = 15\text{ A}, I_G = 1000\text{ mA}, T_j = 250\text{ °C}$ |        | 3.6  |      |      |
| Drain – Source On Resistance | $R_{DS(ON)}$  | $I_D = 15\text{ A}, I_G = 500\text{ mA}, T_j = 25\text{ °C}$   |        | 105  |      | mΩ   |
|                              |               | $I_D = 15\text{ A}, I_G = 1000\text{ mA}, T_j = 175\text{ °C}$ |        | 180  |      |      |
|                              |               | $I_D = 15\text{ A}, I_G = 1000\text{ mA}, T_j = 250\text{ °C}$ |        | 290  |      |      |
| Gate Forward Voltage         | $V_{GS(FWD)}$ | $I_G = 500\text{ mA}, T_j = 25\text{ °C}$                      |        | 3    |      | V    |
|                              |               | $I_G = 500\text{ mA}, T_j = 250\text{ °C}$                     |        | 2.6  |      |      |
| DC Current Gain              | $\beta$       | $V_{DS} = 5\text{ V}, I_D = 20\text{ A}, T_j = 25\text{ °C}$   |        | 115  |      |      |
|                              |               | $V_{DS} = 5\text{ V}, I_D = 20\text{ A}, T_j = 250\text{ °C}$  |        | 75   |      |      |
| <b>Off Characteristics</b>   |               |  |        |      |      |      |
| Drain Leakage Current        | $I_{DSS}$     | $V_R = 650\text{ V}, V_{GS} = 0\text{ V}, T_j = 25\text{ °C}$  |        | 1    |      | μA   |
|                              |               | $V_R = 650\text{ V}, V_{GS} = 0\text{ V}, T_j = 175\text{ °C}$ |        | 7    |      |      |
|                              |               | $V_R = 650\text{ V}, V_{GS} = 0\text{ V}, T_j = 250\text{ °C}$ |        | 45   |      |      |

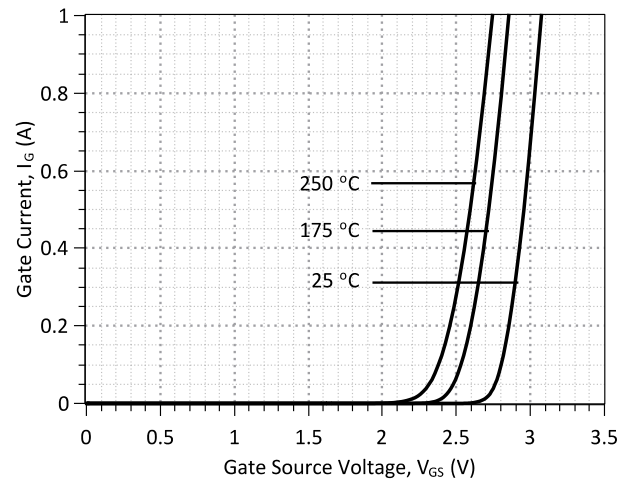
**Electrical Characteristics at  $T_j = 250\text{ }^\circ\text{C}$ , unless otherwise specified**

| Parameter                           | Symbol       | Conditions   | Values |      |               | Unit               |
|-------------------------------------|--------------|--|--------|------|---------------|--------------------|
|                                     |              |  | min.   | typ. | max.          |                    |
| <b>Dynamic Characteristics</b>      |              |  |        |      |               |                    |
| Input Capacitance                   | $C_{iss}$    | $V_{DS} = 35\text{ V}, V_{GS} = 0\text{ V},$<br>$f = 1\text{ MHz}, T_j = 25\text{ }^\circ\text{C}$   |        | 1534 |               | pF                 |
| Output Capacitance                  | $C_{oss}$    |  |        | 157  |               | pF                 |
| Reverse Transfer Capacitance        | $C_{rss}$    |  |        | 157  |               | pF                 |
| <b>Switching Characteristics</b>    |              |  |        |      |               |                    |
| Turn On Delay Time                  | $t_{d(on)}$  | $V_{DD} = 400\text{ V}, I_D = 20\text{ A},$<br>$R_{G(on)} = R_{G(off)} = 22\ \Omega,$<br>$V_{GS} = -8/15\text{ V}, T_j = 175\text{ }^\circ\text{C}$<br>Refer to Figure 10 for gate drive current waveforms |        | 5    |               | ns                 |
| Rise Time                           | $t_r$        |  |        | 37   |               | ns                 |
| Turn Off Delay Time                 | $t_{d(off)}$ |  |        | 68   |               | ns                 |
| Fall Time                           | $t_f$        |  |        | 78   |               | ns                 |
| Turn-On Energy Per Pulse            | $E_{on}$     |  |        | 66   |               | $\mu\text{J}$      |
| Turn-Off Energy Per Pulse           | $E_{off}$    |  |        | 365  |               | $\mu\text{J}$      |
| Total Switching Energy              | $E_{ts}$     |  | 431    |      | $\mu\text{J}$ |                    |
| Turn On Delay Time                  | $t_{d(on)}$  | $V_{DD} = 400\text{ V}, I_D = 10\text{ A},$<br>$R_{G(on)} = R_{G(off)} = 22\ \Omega,$<br>$V_{GS} = -8/15\text{ V}, T_j = 250\text{ }^\circ\text{C}$<br>Refer to Figure 10 for gate drive current waveforms |        | 7    |               | ns                 |
| Rise Time                           | $t_r$        |  |        | 38   |               | ns                 |
| Turn Off Delay Time                 | $t_{d(off)}$ |  |        | 85   |               | ns                 |
| Fall Time                           | $t_f$        |  |        | 86   |               | ns                 |
| Turn-On Energy Per Pulse            | $E_{on}$     |  |        | 64   |               | $\mu\text{J}$      |
| Turn-Off Energy Per Pulse           | $E_{off}$    |  |        | 395  |               | $\mu\text{J}$      |
| Total Switching Energy              | $E_{ts}$     |  | 459    |      | $\mu\text{J}$ |                    |
| <b>Thermal Characteristics</b>      |              |  |        |      |               |                    |
| Thermal resistance, junction - case | $R_{th(jc)}$ |  | 1.4    |      |               | $^\circ\text{C/W}$ |

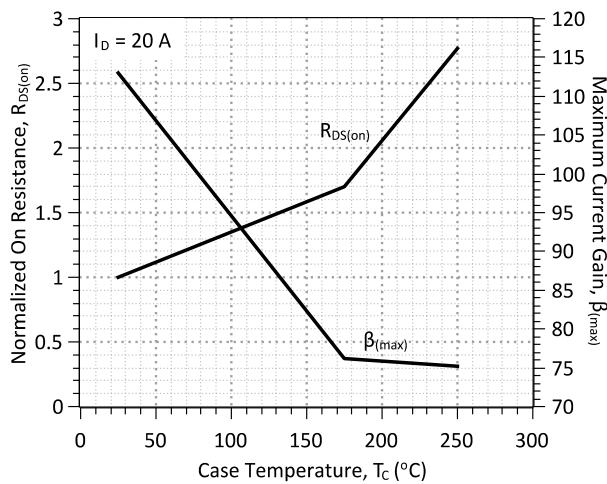

**Figure 1: Typical Output Characteristics at 25 °C**

**Figure 2: Typical Output Characteristics at 175 °C**



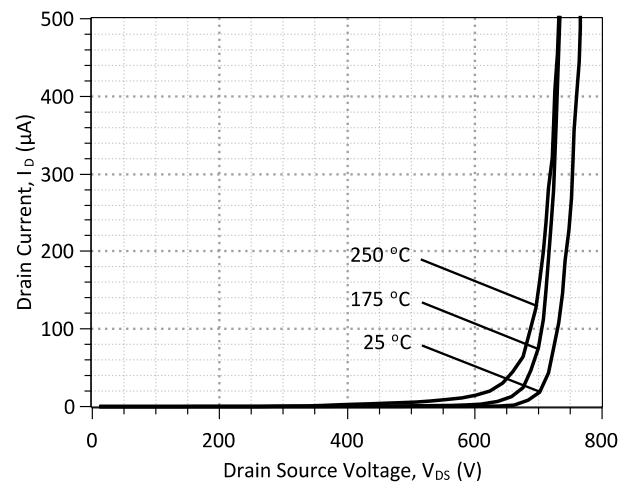
**Figure 3: Typical Output Characteristics at 250 °C**



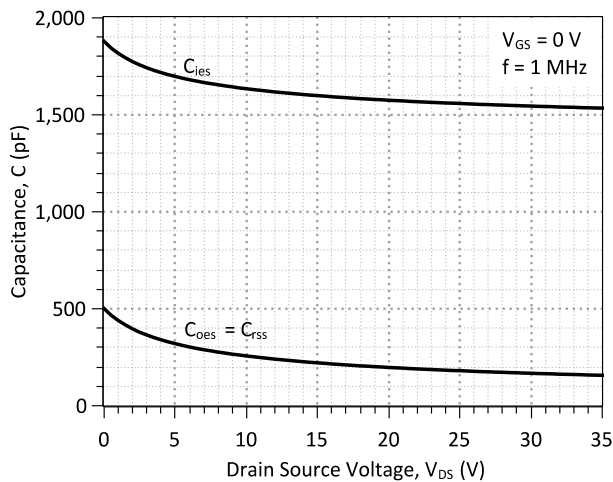
**Figure 4: Typical Gate Source I-V Characteristics vs. Temperature**



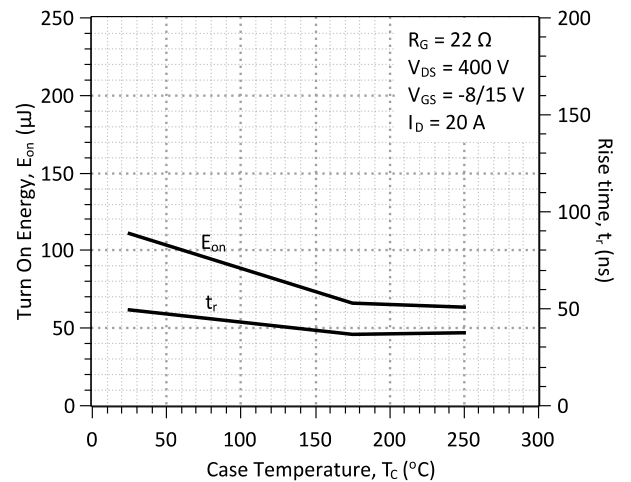
**Figure 5: Normalized On-Resistance and Current Gain vs. Temperature**



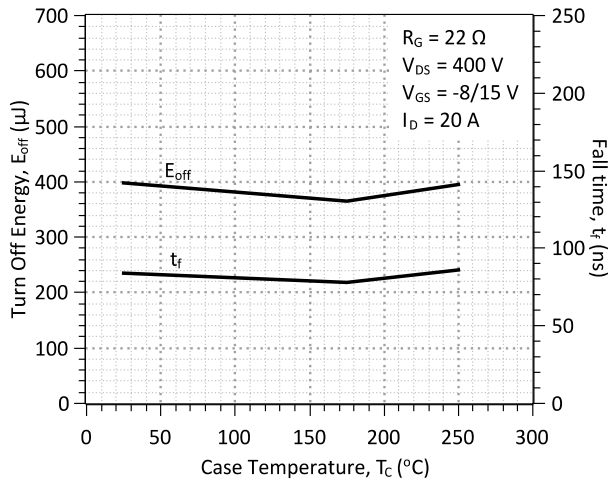
**Figure 6: Typical Blocking Characteristics**



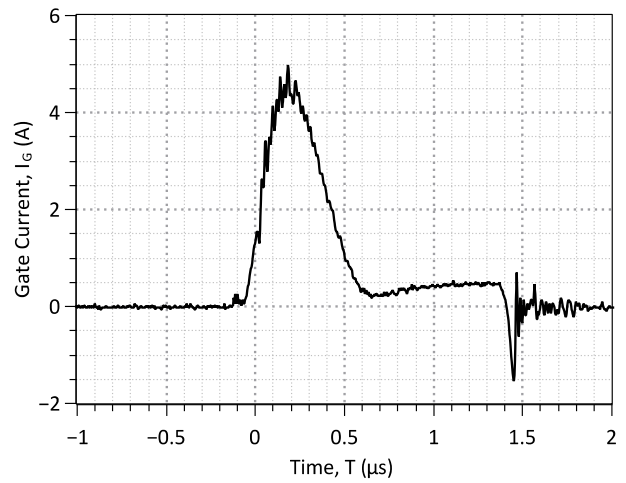
**Figure 7: Typical Capacitance vs Drain-Source Voltage**



**Figure 8: Typical Turn On Losses and Switching Times vs. Temperature**

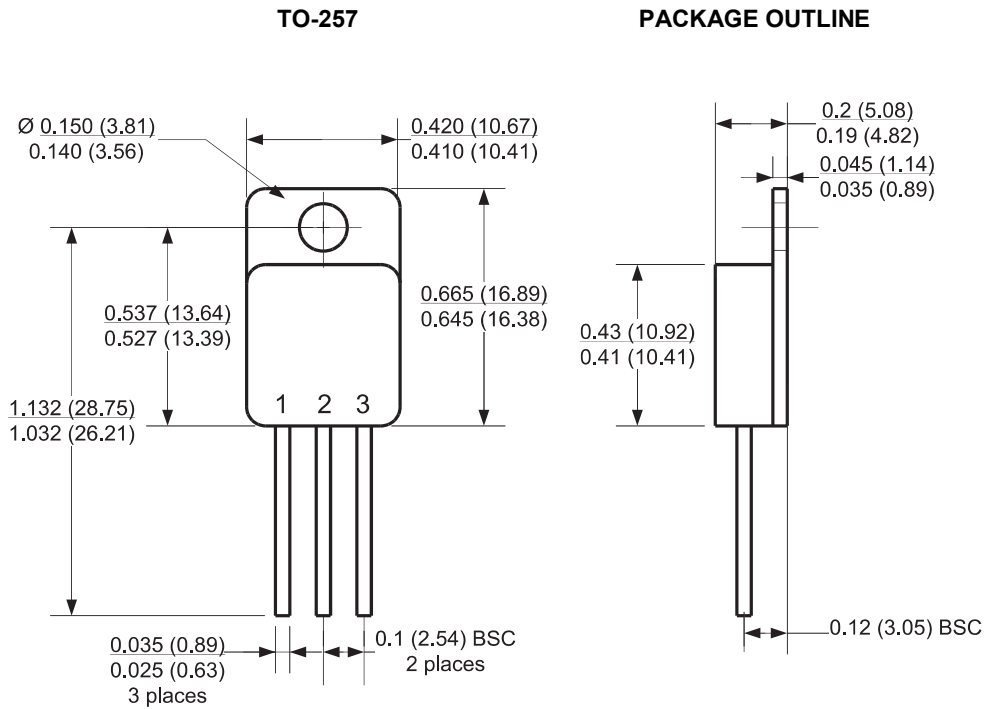


**Figure 9: Typical Turn Off Energy Losses and Switching Times vs. Temperature**



**Figure 10: Typical Gate-Source Switching Waveforms**

**Package Dimensions:**



**NOTE**  
 1. CONTROLLED DIMENSION IS INCH. DIMENSION IN BRACKET IS MILLIMETER.  
 2. DIMENSIONS DO NOT INCLUDE END FLASH, MOLD FLASH, MATERIAL PROTRUSIONS

**Revision History**

| Date       | Revision | Comments        | Supersedes |
|------------|----------|-----------------|------------|
| 2012/08/24 | 0        | Initial release |            |
|            |          |                 |            |

## Published by

GeneSiC Semiconductor, Inc.  
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Dulles, VA 20166

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## SPICE Model Parameters

Copy the following code into a SPICE software program for simulation of the 2N7639-GA device.

```
*      MODEL OF GeneSiC Semiconductor Inc.
*
*      $Revision:   1.0           $
*      $Date:      06-SEP-2013   $
*
*      GeneSiC Semiconductor Inc.
*      43670 Trade Center Place Ste. 155
*      Dulles, VA 20166
*      http://www.genesicsemi.com/index.php/sic-products/sjt
*
*      COPYRIGHT (C) 2013 GeneSiC Semiconductor Inc.
*      ALL RIGHTS RESERVED
*
*      These models are provided "AS IS, WHERE IS, AND WITH NO WARRANTY
*      OF ANY KIND EITHER EXPRESSED OR IMPLIED, INCLUDING BUT NOT LIMITED
*      TO ANY IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A
*      PARTICULAR PURPOSE."
*      Models accurate up to 2 times rated drain current.
*
.model 2N7639 NPN
+ IS      6.03E-47
+ ISE     1.72E-28
+ EG      3.2
+ BF      122
+ BR      0.55
+ IKF     300
+ NF      1
+ NE      1.868
+ RB      0.26
+ RE      0.088
+ RC      0.01
+ CJC     5.68E-10
+ VJC     2.978967839
+ MJC     0.466424924
+ CJE     1.72E-09
+ VJE     2.77859888
+ MJE     0.48415
+ XTI     3
+ XTB     -0.78
+ TRC1    7.00E-02
+ VCEO    800
+ ICRATING 15
+ MFG     GeneSiC_Semiconductor
*
*      End of 2N7639-GA SPICE Model
```